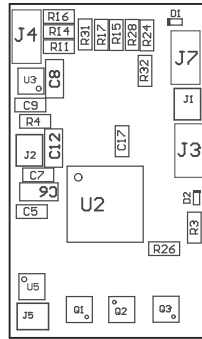


ZZ1 ■Install label in silkscreened box after final wash. Text shall be 8 pt font. Text shall be per the Label Table in the PDF schematic.

ZZ2 ■This Assembly Note will show in the PcbDoc and associated outputs

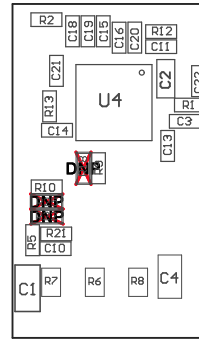
ZZ3 ■This Assembly Note will show in the PcbDoc and associated outputs

ZZ4 ■This Assembly Note will show in the PcbDoc and associated outputs



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.  
ASSEMBLY VARIANT: 001

PCB VIEWED FROM TOP SIDE	BOARD #: TIDA-01587	REV: E2	SUN REV: Not In VersionControl
M5 Assembly Top	TID #: TIDA-01587		
PLOT NAME = Top Assembly Drawing	GENERATED : 2/13/2018	4:16:03 PM	TEXAS INSTRUMENTS



COMPONENTS MARKED 'DNP' SHOULD NOT BE POPULATED.  
 ASSEMBLY VARIANT: 001

PCB VIEWED FROM BOTTOM SIDE	BOARD #: TIDA-01587	REV: E2	SUN REV: Not In VersionControl
M6 Assembly Bottom	TID #: TIDA-01587		
PLOT NAME = Bottom Assembly Drawing	GENERATED : 2/13/2018	4:16:04 PM	TEXAS INSTRUMENTS

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